

Octal D-type flip-flop with reset; positive-edge trigger

74LVC273

FEATURES

- Wide supply voltage range from 1.2 to 3.6 V
- Inputs accept voltages up to 5.5 V
- CMOS low power consumption
- Direct interface with TTL levels
- Output drive capability 50 Ω transmission lines at 85 °C
- Complies with JEDEC standard no. 8-1A
- ESD protection:
HBM EIA/JESD22-A114-A exceeds 2000 V
MM EIA/JESD22-A115-A exceeds 200 V.
- Specified from –40 to +85 °C and –40 to +125 °C.

DESCRIPTION

The 74LVC273 is a low-voltage Si-gate CMOS device, superior to most advanced CMOS compatible TTL families.

The 74LVC273 has eight edge-triggered, D-type flip-flops with individual D inputs and Q outputs. The common clock (CP) and master reset ($\overline{\text{MR}}$) inputs load and reset (clear) all flip-flops simultaneously. The state of each D input, one set-up time before the LOW-to-HIGH clock transition, is transferred to the corresponding output (Qn) of the flip-flop.

All outputs will be forced LOW independently of clock or data inputs by a LOW voltage level on the $\overline{\text{MR}}$ input.

The device is useful for applications where the true output only is required and the clock and master reset are common to all storage elements.

QUICK REFERENCE DATA

GND = 0 V; $T_{\text{amb}} = 25\text{ °C}$; $t_r = t_f \leq 2.5\text{ ns}$.

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
$t_{\text{PHL}}/t_{\text{PLH}}$	propagation delay CP to Qn	$C_L = 50\text{ pF}$; $V_{\text{CC}} = 3.3\text{ V}$	4.8	ns
	propagation delay $\overline{\text{MR}}$ to Qn	$C_L = 50\text{ pF}$; $V_{\text{CC}} = 3.3\text{ V}$	4.8	ns
f_{max}	maximum clock frequency		230	MHz
C_I	input capacitance		5.0	pF
C_{PD}	power dissipation capacitance per flip-flop	outputs disabled; notes 1 and 2	22	pF

Notes

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)

$$P_D = C_{\text{PD}} \times V_{\text{CC}}^2 \times f_i \times N + \Sigma(C_L \times V_{\text{CC}}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in Volts;

N = total load switching outputs;

$\Sigma(C_L \times V_{\text{CC}}^2 \times f_o)$ = sum of the outputs.

2. The definition is $V_I = \text{GND to } V_{\text{CC}}$.

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FUNCTION TABLE

See note 1.

OPERATING MODES	INPUT			OUTPUT
	$\overline{\text{MR}}$	CP	Dn	Qn
Reset (clear)	L	X	X	L
Load '1'	H	↑	h	H
Load '0'	H	↑	l	L

Note

- H = HIGH voltage level;
h = HIGH voltage level one set-up time prior to the HIGH-to-LOW CP transition;
L = LOW voltage level;
l = LOW voltage level one set-up time prior to the HIGH-to-LOW CP transition;
↑ = LOW-to-HIGH transition;
X = don't care.

ORDERING INFORMATION

TYPE NUMBER	PACKAGE				
	TEMPERATURE RANGE	PINS	PACKAGE	MATERIAL	CODE
74LVC273D	-40 to +125 °C	20	SO20	plastic	SOT163-1
74LVC273DB	-40 to +125 °C	20	SSOP20	plastic	SOT339-1
74LVC273PW	-40 to +125 °C	20	TSSOP20	plastic	SOT360-1
74LVC273BQ	-40 to +125 °C	20	DHVQFN20	plastic	SOT764-1

PINNING

PIN	SYMBOL	DESCRIPTION
1	$\overline{\text{MR}}$	master reset input (active LOW)
2	Q0	flip-flop output
3	D0	data input
4	D1	data input
5	Q1	flip-flop output
6	Q2	flip-flop output
7	D2	data input
8	D3	data input
9	Q3	flip-flop output
10	GND	ground (0 V)

PIN	SYMBOL	DESCRIPTION
11	CP	clock input (LOW-to-HIGH, edge-triggered)
12	Q4	flip-flop output
13	D4	data input
14	D5	data input
15	Q5	flip-flop output
16	Q6	flip-flop output
17	D6	data input
18	D7	data input
19	Q7	flip-flop output
20	V _{CC}	supply voltage

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CC}	supply voltage	maximum speed performance	2.7	3.6	V
		low-voltage applications	1.2	3.6	V
V_I	input voltage		0	5.5	V
V_O	output voltage		0	V_{CC}	V
T_{amb}	operating ambient temperature	in free air	-40	+125	°C
t_r, t_f	input rise and fall times	$V_{CC} = 1.2$ to 2.7 V	0	20	ns/V
		$V_{CC} = 2.7$ to 3.6 V	0	10	ns/V

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CC}	supply voltage		-0.5	+6.5	V
I_{IK}	input diode current	$V_I < 0$	-	-50	mA
V_I	input voltage	note 1	-0.5	+6.5	V
I_{OK}	output diode current	$V_O > V_{CC}$ or $V_O < 0$	-	50	mA
V_O	output voltage	note 1	-0.5	$V_{CC} + 0.5$	V
I_O	output source or sink current	$V_O = 0$ to V_{CC}	-	±50	mA
I_{CC}, I_{GND}	V_{CC} or GND current		-	±100	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	power dissipation per package	$T_{amb} = -40$ to $+125$ °C; note 2	-	500	mW

Notes

- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- For SO20 packages: above 70 °C derate linearly with 8 mW/K.
For SSOP20 and TSSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.
For DHVQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

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DC CHARACTERISTICS

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V _{CC} (V)				
T_{amb} = -40 to +85 °C; note 1							
V _{IH}	HIGH-level input voltage		1.2	V _{CC}	–	–	V
			2.7 to 3.6	2.0	–	–	V
V _{IL}	LOW-level input voltage		1.2	–	–	GND	V
			2.7 to 3.6	–	–	0.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL} I _O = -100 μA	2.7 to 3.6	V _{CC} - 0.2	–	–	V
		I _O = -12 mA	2.7	V _{CC} - 0.5	–	–	V
		I _O = -18 mA	3.0	V _{CC} - 0.6	–	–	V
		I _O = -24 mA	3.0	V _{CC} - 0.8	–	–	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL} I _O = 100 μA	2.7 to 3.6	–	–	0.2	V
		I _O = 12 mA	2.7	–	–	0.4	V
		I _O = 24 mA	3.0	–	–	0.55	V
I _{LI}	input leakage current	V _I = 5.5 V or GND	3.6	–	±0.1	±5	μA
I _{CC}	quiescent supply current	V _I = V _{CC} or GND; I _O = 0	3.6	–	0.1	10	μA
ΔI _{CC}	additional quiescent supply current per input pin	V _I = V _{CC} - 0.6 V; I _O = 0	2.7 to 3.6	–	5	500	μA

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SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		OTHER	V _{CC} (V)				
T_{amb} = -40 to +125 °C							
V _{IH}	HIGH-level input voltage		1.2	V _{CC}	-	-	V
			2.7 to 3.6	2.0	-	-	V
V _{IL}	LOW-level input voltage		1.2	-	-	GND	V
			2.7 to 3.6	-	-	0.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL} I _O = -100 μA	2.7 to 3.6	V _{CC} - 0.3	-	-	V
		I _O = -12 mA	2.7	V _{CC} - 0.65	-	-	V
		I _O = -18 mA	3.0	V _{CC} - 0.75	-	-	V
		I _O = -24 mA	3.0	V _{CC} - 1.0	-	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL} I _O = 100 μA	2.7 to 3.6	-	-	0.3	V
		I _O = 12 mA	2.7	-	-	0.6	V
		I _O = 24 mA	3.0	-	-	0.8	V
I _{LI}	input leakage current	V _I = 5.5 V or GND	3.6	-	-	±20	μA
I _{CC}	quiescent supply current	V _I = V _{CC} or GND; I _O = 0	3.6	-	-	40	μA
ΔI _{CC}	additional quiescent supply current per input pin	V _I = V _{CC} - 0.6 V; I _O = 0	2.7 to 3.6	-	-	5000	μA

Note

1. Typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

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AC CHARACTERISTICS

GND = 0 V; $t_r = t_f = 2.5$ ns; $C_L = 50$ pF; $R_L = 500$ Ω .

SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		WAVEFORMS	V _{CC} (V)				
T_{amb} = -40 to +85 °C; note 1							
t _{PHL} /t _{PLH}	propagation delay CP to Qn	see Fig.5 and Fig.8	1.2	–	18	–	ns
			2.7	1.5	4.9	8.4	ns
			3.0 to 3.6	1.5	4.8 ⁽²⁾	8.2	ns
t _{PHL}	propagation delay \overline{MR} to Qn	see Fig.6 and Fig.8	1.2	–	18	–	ns
			2.7	1.5	5.2	8.9	ns
			3.0 to 3.6	1.5	4.8 ⁽²⁾	8.7	ns
t _w	clock pulse width HIGH or LOW	see Fig.5 and Fig.8	1.2	–	–	–	ns
			2.7	5.0	1.8	–	ns
			3.0 to 3.6	4.0	1.2 ⁽²⁾	–	ns
t _w	master reset pulse width LOW	see Fig.6 and Fig.8	1.2	–	–	–	ns
			2.7	5.0	1.7	–	ns
			3.0 to 3.6	4.0	1.2 ⁽²⁾	–	ns
t _{rem}	removal time \overline{MR} to CP	see Fig.6 and Fig.8	1.2	–	–	–	ns
			2.7	+3.0	-1.0	–	ns
			3.0 to 3.6	+2.0	-1.0 ⁽²⁾	–	ns
t _{su}	set-up time Dn to CP	see Fig.7 and Fig.8	1.2	–	–	–	ns
			2.7	3.0	1.0	–	ns
			3.0 to 3.6	1.0	0.0 ⁽²⁾	–	ns
t _h	hold time Dn to CP	see Fig.7 and Fig.8	1.2	–	–	–	ns
			2.7	+3.0	-0.2	–	ns
			3.0 to 3.6	1.0	0.0 ⁽²⁾	–	ns
f _{max}	maximum clock frequency	see Fig.5 and Fig.8	1.2	–	–	–	MHz
			2.7	150	–	–	MHz
			3.0 to 3.6	150	230 ⁽²⁾	–	MHz
t _{sk(0)}	skew	note 3	3.0 to 3.6	–	–	1.0	ns

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SYMBOL	PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
		WAVEFORMS	V _{CC} (V)				
T_{amb} = -40 to +125 °C							
t _{PHL} /t _{PLH}	propagation delay CP to Qn	see Fig.5 and Fig.8	1.2	–	–	–	ns
			2.7	1.5	–	10.5	ns
			3.0 to 3.6	1.5	–	10.5	ns
t _{PHL}	propagation delay $\overline{\text{MR}}$ to Qn	see Fig.6 and Fig.8	1.2	–	–	–	ns
			2.7	1.5	–	11.5	ns
			3.0 to 3.6	1.5	–	11.0	ns
t _w	clock pulse width HIGH or LOW	see Fig.5 and Fig.8	1.2	–	–	–	ns
			2.7	5.0	–	–	ns
			3.0 to 3.6	4.0	–	–	ns
t _w	master reset pulse width LOW	see Fig.6 and Fig.8	1.2	–	–	–	ns
			2.7	5.0	–	–	ns
			3.0 to 3.6	4.0	–	–	ns
t _{rem}	removal time $\overline{\text{MR}}$ to CP	see Fig.6 and Fig.8	1.2	–	–	–	ns
			2.7	3.0	–	–	ns
			3.0 to 3.6	2.0	–	–	ns
t _{su}	set-up time Dn to CP	see Fig.7 and Fig.8	1.2	–	–	–	ns
			2.7	3.0	–	–	ns
			3.0 to 3.6	1.0	–	–	ns
t _h	hold time Dn to CP	see Fig.7 and Fig.8	1.2	–	–	–	ns
			2.7	3.0	–	–	ns
			3.0 to 3.6	1.0	–	–	ns
f _{max}	maximum clock frequency	see Fig.5 and Fig.8	1.2	–	–	–	MHz
			2.7	150	–	–	MHz
			3.0 to 3.6	150	–	–	MHz
t _{sk(0)}	skew	note 3	3.0 to 3.6	–	–	1.5	ns

Notes

1. All typical values are measured at T_{amb} = 25 °C.
2. This typical value is measured at V_{CC} = 3.3 V.
3. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

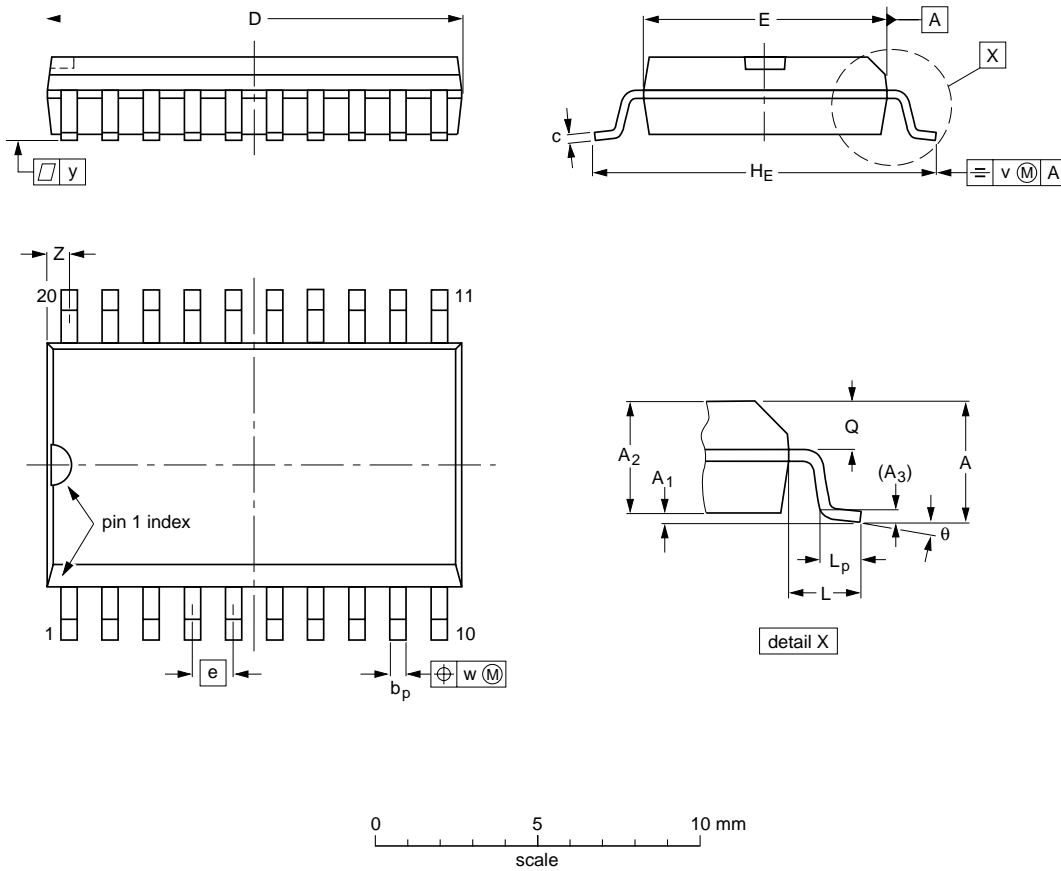
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PACKAGE OUTLINES

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	2.65	0.3 0.1	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

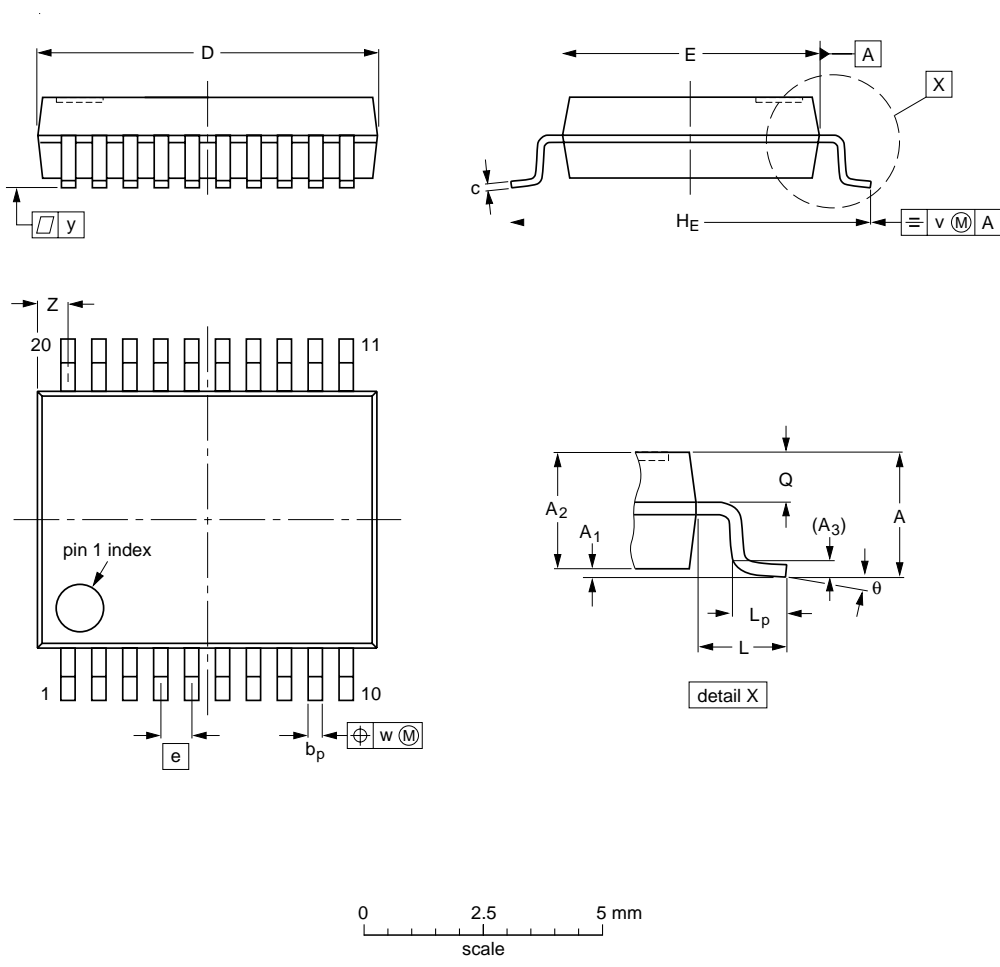
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION
	IEC	JEDEC	JEITA		
SOT163-1	075E04	MS-013			

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION
	IEC	JEDEC	JEITA		
SOT339-1		MO-150			